

UTT48NN06**POWER MOSFET**

**48A, 60V N-CHANNEL
POWER MOSFET**

■ DESCRIPTION

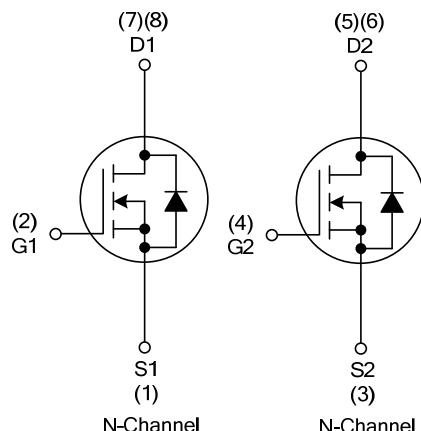
The UTC **UTT48NN06** is a N-channel mode power MOSFET using UTC's advanced technology to provide customers with a minimum on-state resistance, low gate charge and high switching speed.

The UTC **UTT48NN06** is suitable for high voltage synchronous rectifier and DC/DC converters, etc.

■ FEATURES

- * $R_{DS(ON)} \leq 20 \text{ m}\Omega @ V_{GS}=10\text{V}, I_D=24\text{A}$
- * $R_{DS(ON)} \leq 30 \text{ m}\Omega @ V_{GS}=4.5\text{V}, I_D=24\text{A}$
- * High Switching Speed
- * High Cell Density Trench Technology

■ SYMBOL



■ ORDERING INFORMATION

| Ordering Number | | Package | Pin Assignment | | | | | | | | Packing |
|--------------------|--------------------|---------|----------------|----|----|----|----|----|----|----|-----------|
| Lead Free | Halogen Free | | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | |
| UTT48NN06L-S08-R | UTT48NN06G-S08-R | SOP-8 | S1 | G1 | S2 | G2 | D2 | D2 | D1 | D1 | Tape Reel |
| UTT48NN06L-P5060-R | UTT48NN06G-P5060-R | PDFN5x6 | S1 | G1 | S2 | G2 | D2 | D2 | D1 | D1 | Tape Reel |

Note: Pin Assignment: G: Gate D: Drain S: Source

| | | |
|------------------|------------------|---|
| UTT48NN06G-S08-R | (1)Packing Type | (1) R: Tape Reel |
| | (2)Package Type | (2) S08: SOP-8, P5060: PDFN5x6 |
| | (3)Green Package | (3) G: Halogen Free and Lead Free, L: Lead Free |

■ MARKING

| SOP-8 | PDFN5×6 |
|---|---|
| <p>8 7 6 5 UTC □□□□ 48NN06 □ • 1 2 3 4</p> <p>Date Code L: Lead Free G: Halogen Free Lot Code</p> | <p>UTC UTT 48NN06 • □□□□□</p> <p>Lot Code ← Date Code</p> |

■ ABSOLUTE MAXIMUM RATING ($T_c=25^\circ\text{C}$, unless otherwise specified)

| PARAMETER | | | SYMBOL | RATINGS | UNIT | |
|--------------------------------------|---------------------------|--------|-----------|-----------|------------|------------------|
| Drain-Source Voltage | | | V_{DSS} | 60 | V | |
| Gate-Source Voltage | | | V_{GSS} | ± 20 | V | |
| Drain Current | Continuous | Total | PDFN5X6 | 48 | A | |
| | | | SOP-8 | 16 | | |
| | | Single | PDFN5X6 | 24 | A | |
| | | | SOP-8 | 8 | | |
| | Pulsed (Note 2) | Single | I_{DM} | 108 | A | |
| Avalanche Energy | Single Pulsed (Note 3) | | E_{AS} | 26 | mJ | |
| Peak Diode Recovery dv/dt (Note 4) | | | dv/dt | 2.3 | V/nS | |
| Power Dissipation (Note 5) | SOP-8 | P_D | 5 | W | | |
| | PDFN5x6 | | 25 | W | | |
| | Junction Temperature | | | T_J | +150 | $^\circ\text{C}$ |
| | Storage Temperature Range | | | T_{STG} | -55 ~ +150 | $^\circ\text{C}$ |

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature

3. $L=0.1\text{mH}$, $I_{AS}=23\text{A}$, $V_{DD}=50\text{V}$, $R_G = 25\Omega$, Starting $T_J = 25^\circ\text{C}$

4. $I_{SD} \leq 30\text{A}$, $dI/dt \leq 100\text{A}/\mu\text{s}$, $V_{DD} \leq V_{(BR)DSS}$, $T_J \leq 25^\circ\text{C}$

5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

■ THERMAL DATA

| PARAMETER | | SYMBOL | RATINGS | UNIT |
|---------------------|---------|---------------|-----------|--------------------|
| Junction to Ambient | SOP-8 | θ_{JA} | 125 | $^\circ\text{C/W}$ |
| | PDFN5x6 | | 65 | $^\circ\text{C/W}$ |
| Junction to Case | SOP-8 | θ_{JC} | 25 (Note) | $^\circ\text{C/W}$ |
| | PDFN5x6 | | 5 (Note) | $^\circ\text{C/W}$ |

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

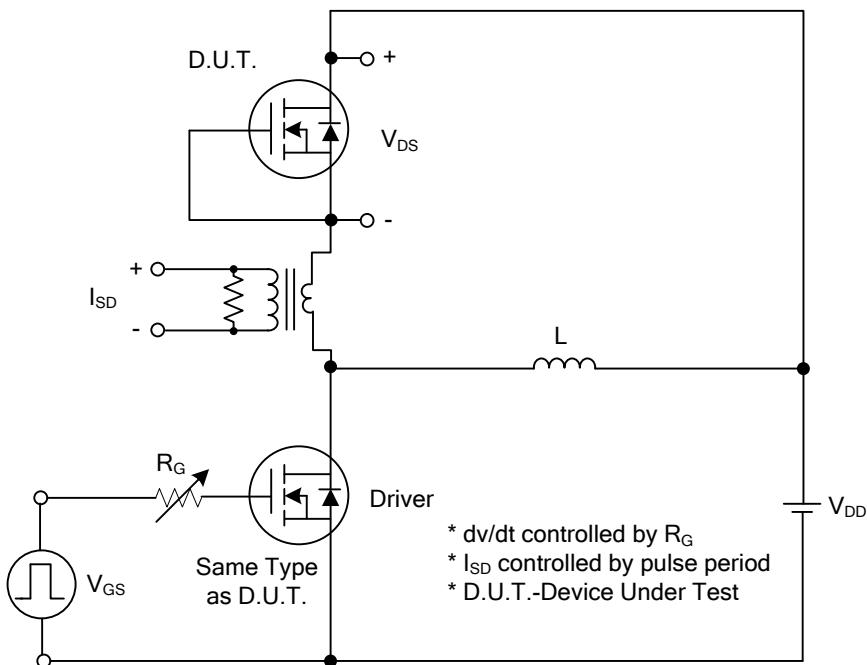
■ ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$, unless otherwise specified)

| PARAMETER | SYMBOL | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|--|----------------------------|---|-----|------|------|------------------|
| OFF CHARACTERISTICS | | | | | | |
| Drain-Source Breakdown Voltage | BV_{DSS} | $I_D=250\mu\text{A}, V_{\text{GS}}=0\text{V}$ | 60 | | | V |
| Drain-Source Leakage Current | I_{DSS} | $V_{\text{DS}}=60\text{V}, V_{\text{GS}}=0\text{V}$ | | | 1 | μA |
| Gate-Source Leakage Current | Forward | $V_{\text{GS}}=+20\text{V}, V_{\text{DS}}=0\text{V}$ | | | +100 | nA |
| | Reverse | $V_{\text{GS}}=-20\text{V}, V_{\text{DS}}=0\text{V}$ | | | -100 | nA |
| ON CHARACTERISTICS | | | | | | |
| Gate Threshold Voltage | $V_{\text{GS}(\text{TH})}$ | $V_{\text{DS}}=V_{\text{GS}}, I_D=250\mu\text{A}$ | 1.0 | | 3.0 | V |
| Static Drain-Source On-State Resistance | $R_{\text{DS}(\text{ON})}$ | $V_{\text{GS}}=10\text{V}, I_D=24\text{A}$ | | | 20 | $\text{m}\Omega$ |
| | | $V_{\text{GS}}=4.5\text{V}, I_D=24\text{A}$ | | | 30 | $\text{m}\Omega$ |
| DYNAMIC PARAMETERS | | | | | | |
| Input Capacitance | C_{ISS} | $V_{\text{GS}}=0\text{V}, V_{\text{DS}}=25\text{V}, f=1.0\text{MHz}$ | | 2150 | | pF |
| Output Capacitance | C_{OSS} | | | 160 | | pF |
| Reverse Transfer Capacitance | C_{RSS} | | | 125 | | pF |
| SWITCHING PARAMETERS | | | | | | |
| Total Gate Charge (Note 1) | Q_G | $V_{\text{DS}}=48\text{V}, V_{\text{GS}}=10\text{V}, I_D=48\text{A}$ (Note 1, 2) | | 64 | | nC |
| Gate to Source Charge | Q_{GS} | | | 9 | | nC |
| Gate to Drain Charge | Q_{GD} | | | 20 | | nC |
| Turn-on Delay Time (Note 1) | $t_{\text{D}(\text{ON})}$ | $V_{\text{DS}}=30\text{V}, V_{\text{GS}}=10\text{V}, I_D=48\text{A}, R_G=3\Omega$ (Note 1, 2) | | 6.6 | | ns |
| Rise Time | t_R | | | 18 | | ns |
| Turn-off Delay Time | $t_{\text{D}(\text{OFF})}$ | | | 38 | | ns |
| Fall-Time | t_F | | | 21 | | ns |
| SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS | | | | | | |
| Maximum Body-Diode Continuous Current | I_S | | | | 48 | A |
| Maximum Body-Diode Pulsed Current | I_{SM} | | | | 108 | A |
| Drain-Source Diode Forward Voltage (Note 1) | V_{SD} | $I_S=48\text{A}, V_{\text{GS}}=0\text{V}$ | | | 1.4 | V |
| Reverse Recovery Time (Note 1) | t_{rr} | $I_S=30\text{A}, V_{\text{GS}}=0\text{V}, dI/dt=100\text{A}/\mu\text{s}$ | | | 20 | nS |
| Reverse Recovery Charge | Q_{rr} | | | | 11 | nC |

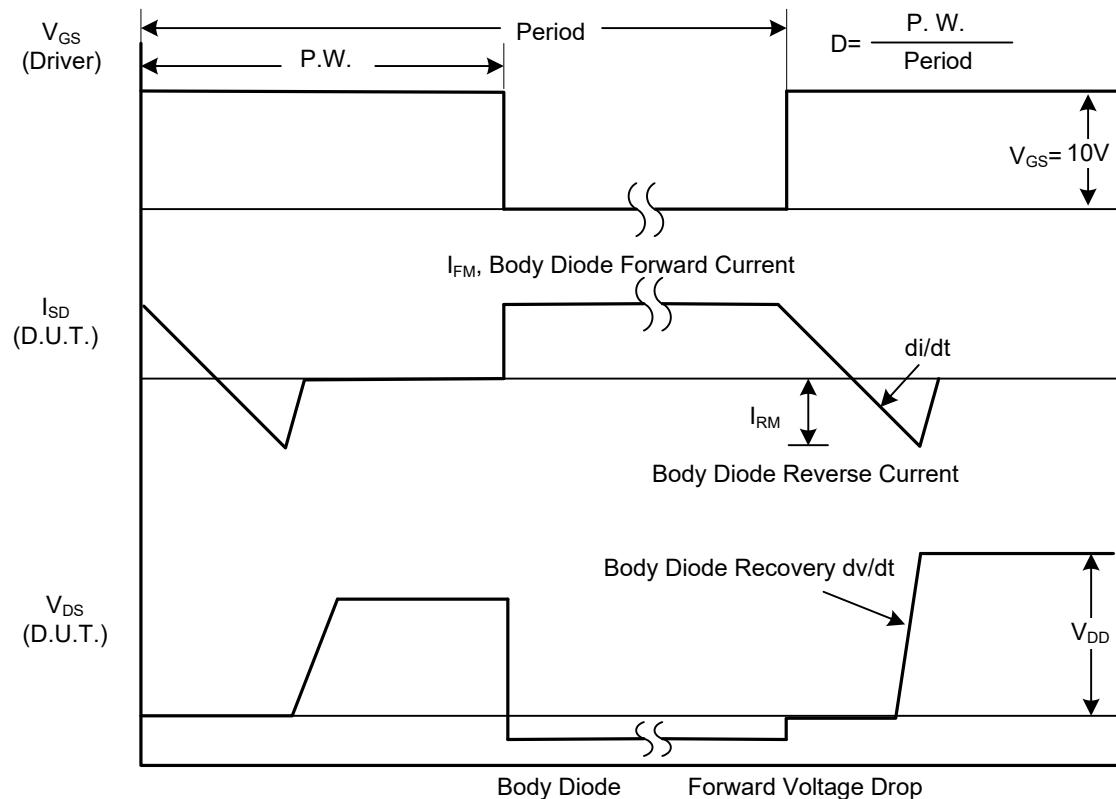
Notes: 1. Pulse Test : Pulse width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$.

2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

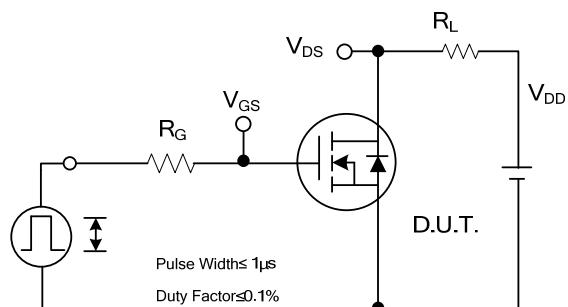


Peak Diode Recovery dv/dt Test Circuit

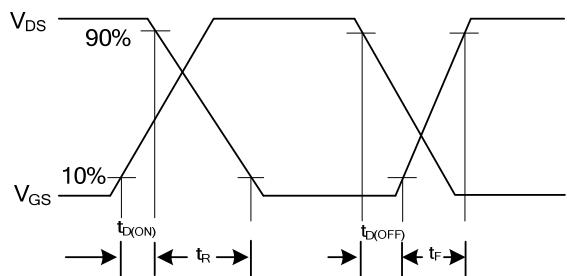


Peak Diode Recovery dv/dt Waveforms

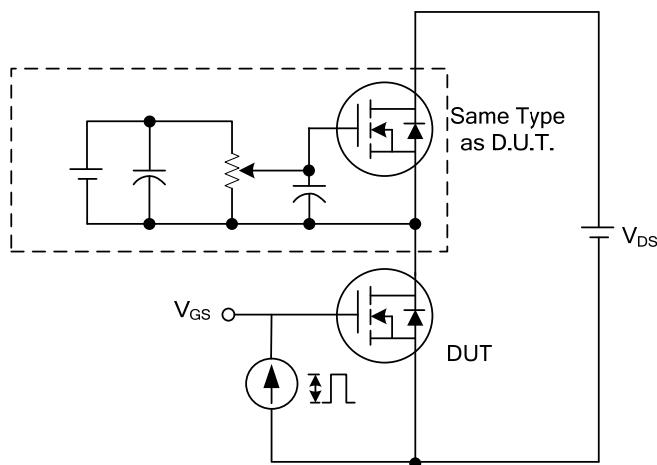
■ TEST CIRCUITS AND WAVEFORMS



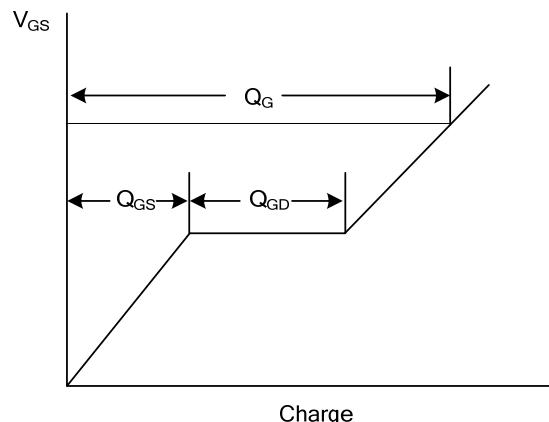
Switching Test Circuit



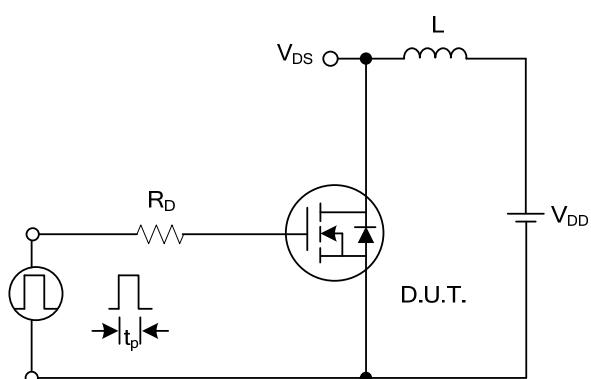
Switching Waveforms



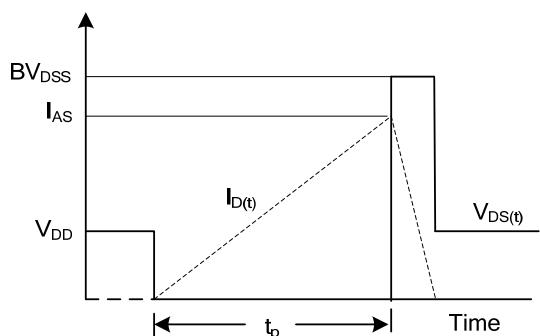
Gate Charge Test Circuit



Gate Charge Waveform

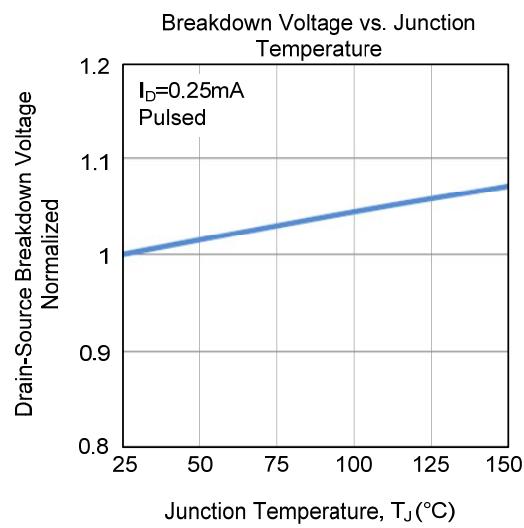
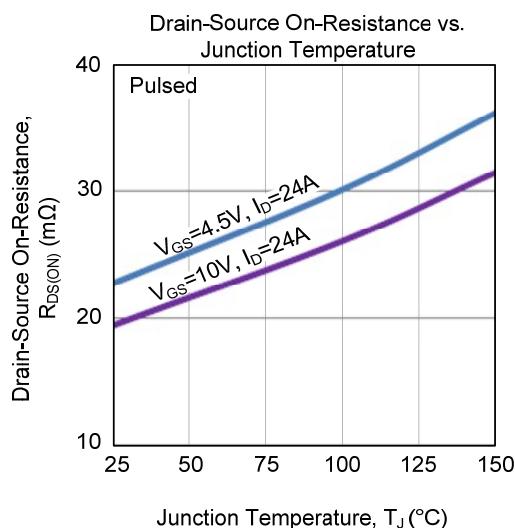
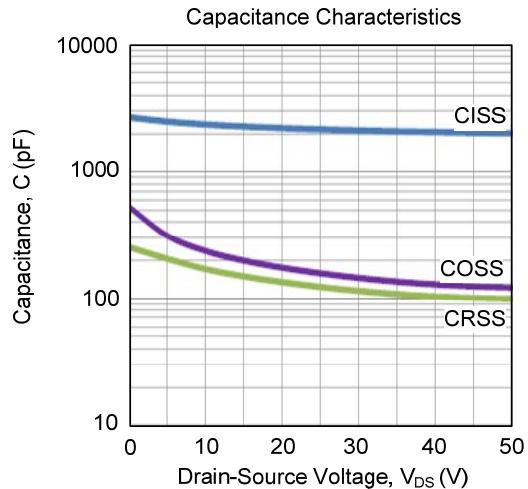
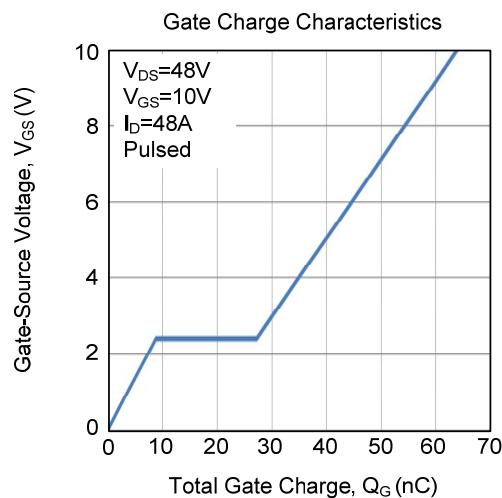
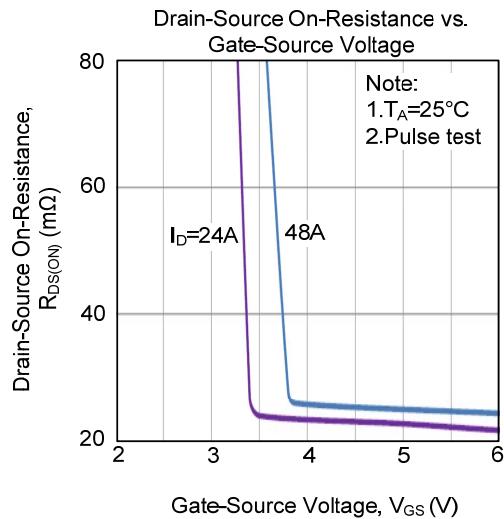
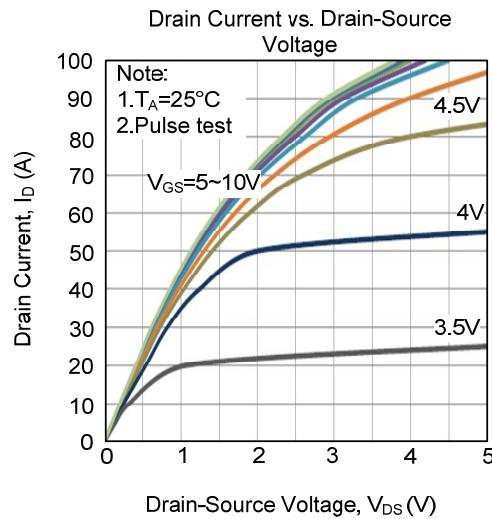


Unclamped Inductive Switching Test Circuit

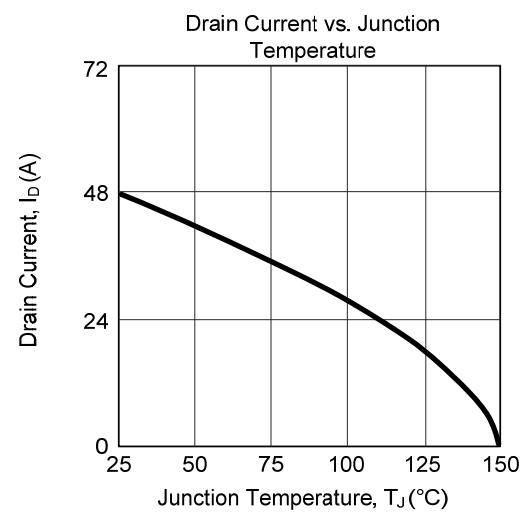
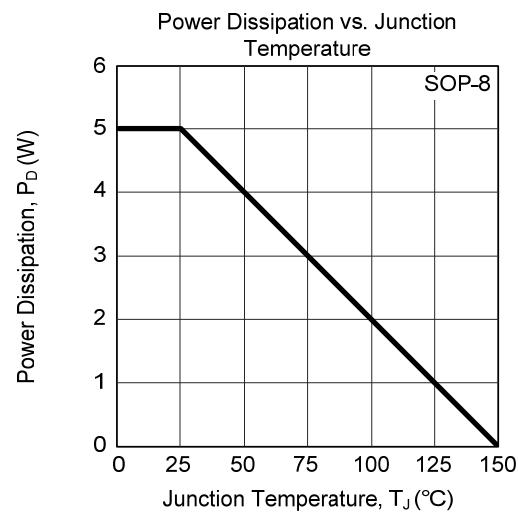
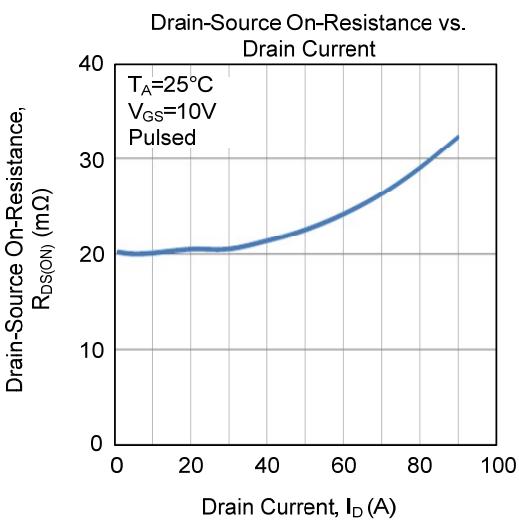
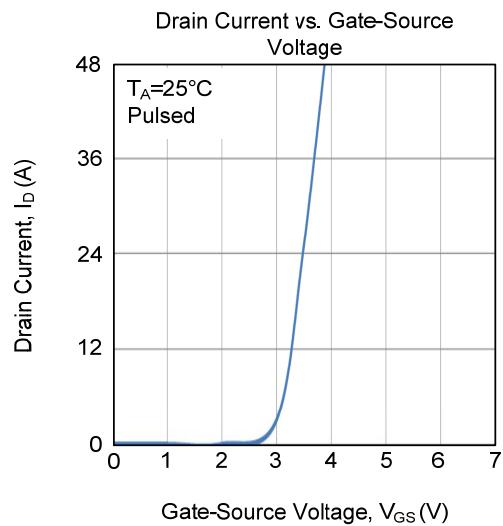
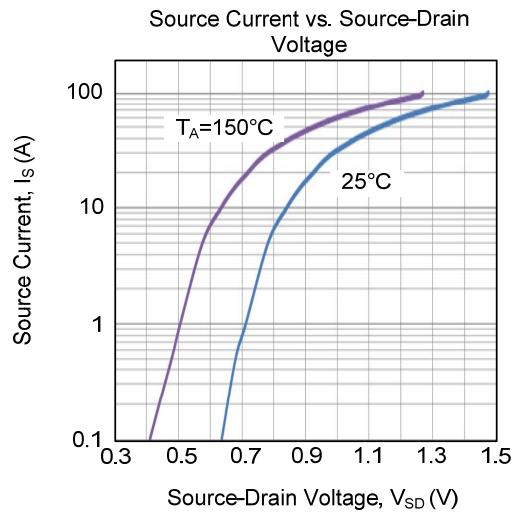
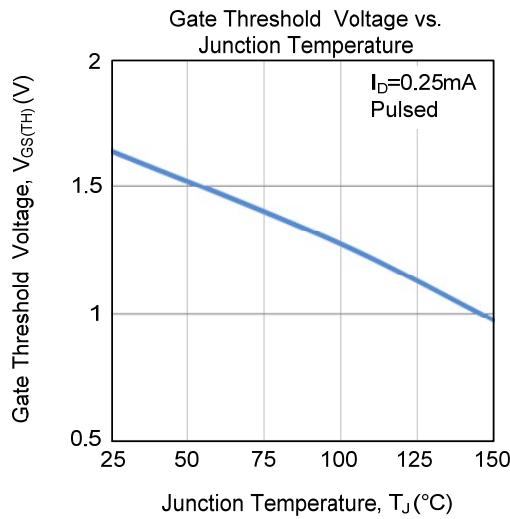


Unclamped Inductive Switching Waveforms

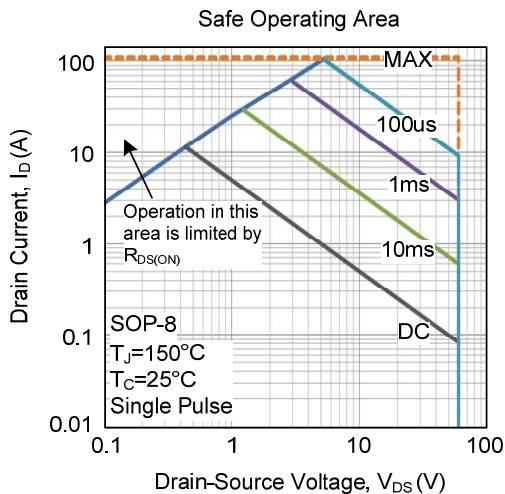
■ TYPICAL CHARACTERISTICS



■ TYPICAL CHARACTERISTICS (Cont.)



■ TYPICAL CHARACTERISTICS (Cont.)



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